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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I2S, POR, PWM, WDT
Number of I/O	19
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	32K x 8
/oltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 9x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx250f128b-50i-ss

TABLE 1: PIC32MX1XX 28/36/44-PIN GENERAL PURPOSE FAMILY FEATURES

				Rem	appab	le Pe	riphe	rals					_		ls)				
Device	Pins	Program Memory (KB) ⁽¹⁾	Data Memory (KB)	Remappable Pins	Timers ⁽²⁾ /Capture/Compare	UART	SPI/I ² S	External Interrupts ⁽³⁾	Analog Comparators	USB On-The-Go (OTG)	l ² C	PMP	DMA Channels (Programmable/Dedicated)	СТМО	10-bit 1 Msps ADC (Channels)	RTCC	I/O Pins	JTAG	Packages
PIC32MX110F016B	28	16+3	4	20	5/5/5	2	2	5	3	Ν	2	Υ	4/0	Υ	10	Υ	21	Υ	SOIC, SSOP, SPDIP, QFN
PIC32MX110F016C	36	16+3	4	24	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	12	Υ	25	Υ	VTLA
PIC32MX110F016D	44	16+3	4	32	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	13	Y	35	Υ	VTLA, TQFP, QFN
PIC32MX120F032B	28	32+3	8	20	5/5/5	2	2	5	3	N	2	Υ	4/0	Y	10	Y	21	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX120F032C	36	32+3	8	24	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	12	Υ	25	Υ	VTLA
PIC32MX120F032D	44	32+3	8	32	5/5/5	2	2	5	3	Ν	2	Υ	4/0	Υ	13	Υ	35	Υ	VTLA, TQFP, QFN
PIC32MX130F064B	28	64+3	16	20	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	10	Υ	21	Υ	SOIC, SSOP, SPDIP, QFN
PIC32MX130F064C	36	64+3	16	24	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	12	Υ	25	Υ	VTLA
PIC32MX130F064D	44	64+3	16	32	5/5/5	2	2	5	3	N	2	Υ	4/0	Y	13	Y	35	Υ	VTLA, TQFP, QFN
PIC32MX150F128B	28	128+3	32	20	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	10	Υ	21	Υ	SOIC, SSOP, SPDIP, QFN
PIC32MX150F128C	36	128+3	32	24	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	12	Υ	25	Υ	VTLA
PIC32MX150F128D	44	128+3	32	32	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	13	Υ	35	Υ	VTLA, TQFP, QFN
PIC32MX130F256B	28	256+3	16	20	5/5/5	2	2	5	3	N	2	Υ	4/0	Y	10	Υ	21	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX130F256D	44	256+3	16	32	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	13	Υ	35	Υ	VTLA, TQFP, QFN
PIC32MX170F256B	28	256+3	64	20	5/5/5	2	2	5	3	N	2	Υ	4/0	Y	10	Υ	21	Υ	SOIC, SSOP, SPDIP, QFN
PIC32MX170F256D	44	256+3	64	32	5/5/5	2	2	5	3	N	2	Υ	4/0	Υ	13	Υ	35	Υ	VTLA, TQFP, QFN

Note 1: This device features 3 KB of boot Flash memory.

3: Four out of five external interrupts are remappable.

^{2:} Four out of five timers are remappable.

TABLE 5: PIN NAMES FOR 28-PIN GENERAL PURPOSE DEVICES

28-PIN QFN (TOP VIEW)(1,2,3.4)

PIC32MX110F016B PIC32MX120F032B PIC32MX130F064B PIC32MX130F256B PIC32MX150F128B PIC32MX170F256B

28

1

Pin #	Full Pin Name
1	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0
2	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1
3	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2
4	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3
5	Vss
6	OSC1/CLKI/RPA2/RA2
7	OSC2/CLKO/RPA3/PMA0/RA3
8	SOSCI/RPB4/RB4
9	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4
10	VDD
11	PGED3/RPB5/PMD7/RB5
12	PGEC3/RPB6/PMD6/RB6
13	TDI/RPB7/CTED3/PMD5/INT0/RB7
14	TCK/RPB8/SCL1/CTED10/PMD4/RB8

Pin#	Full Pin Name
15	TDO/RPB9/SDA1/CTED4/PMD3/RB9
16	Vss
17	VCAP
18	PGED2/RPB10/CTED11/PMD2/RB10
19	PGEC2/TMS/RPB11/PMD1/RB11
20	AN12/PMD0/RB12
21	AN11/RPB13/CTPLS/PMRD/RB13
22	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14
23	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
24	AVss
25	AVDD
26	MCLR
27	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0
28	VREF-/CVREF-/AN1/RPA1/CTED2/RA1

Note

- 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and **Section 11.3 "Peripheral Pin Select"** for restrictions
- 2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.
- 3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.
- 4: Shaded pins are 5V tolerant.

TABLE 14: PIN NAMES FOR 44-PIN USB DEVICES

44-PIN VTLA (TOP VIEW)(1,2,3,5)

PIC32MX210F016D PIC32MX220F032D PIC32MX230F064D PIC32MX230F256D PIC32MX250F128D PIC32MX270F256D

44

Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9
2	RPC6/PMA1/RC6
3	RPC7/PMA0/RC7
4	RPC8/PMA5/RC8
5	RPC9/CTED7/PMA6/RC9
6	Vss
7	VCAP
8	PGED2/RPB10/D+/CTED11/RB10
9	PGEC2/RPB11/D-/RB11
10	Vusb3v3
11	AN11/RPB13/CTPLS/PMRD/RB13
12	PGED4 ⁽⁴⁾ /TMS/PMA10/RA10
13	PGEC4 ⁽⁴⁾ /TCK/CTED8/PMA7/RA7
14	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
16	AVss
17	AVDD
18	MCLR
19	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0
20	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1

Pin#	Full Pin Name
23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2
24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3
25	AN6/RPC0/RC0
26	AN7/RPC1/RC1
27	AN8/RPC2/PMA2/RC2
28	VDD
29	Vss
30	OSC1/CLKI/RPA2/RA2
31	OSC2/CLKO/RPA3/RA3
32	TDO/RPA8/PMA8/RA8
33	SOSCI/RPB4/RB4
34	SOSCO/RPA4/T1CK/CTED9/RA4
35	TDI/RPA9/PMA9/RA9
36	AN12/RPC3/RC3
37	RPC4/PMA4/RC4
38	RPC5/PMA3/RC5
39	Vss
40	VDD
41	RPB5/USBID/RB5
42	VBUS
43	RPB7/CTED3/PMD5/INT0/RB7
44	RPB8/SCL1/CTED10/PMD4/RB8

Note

- 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and **Section 11.3 "Peripheral Pin Select"** for restrictions.
- 2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.
- 3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.
- 4: This pin function is not available on PIC32MX210F016D and PIC32MX220F032D devices.
- 5: Shaded pins are 5V tolerant.

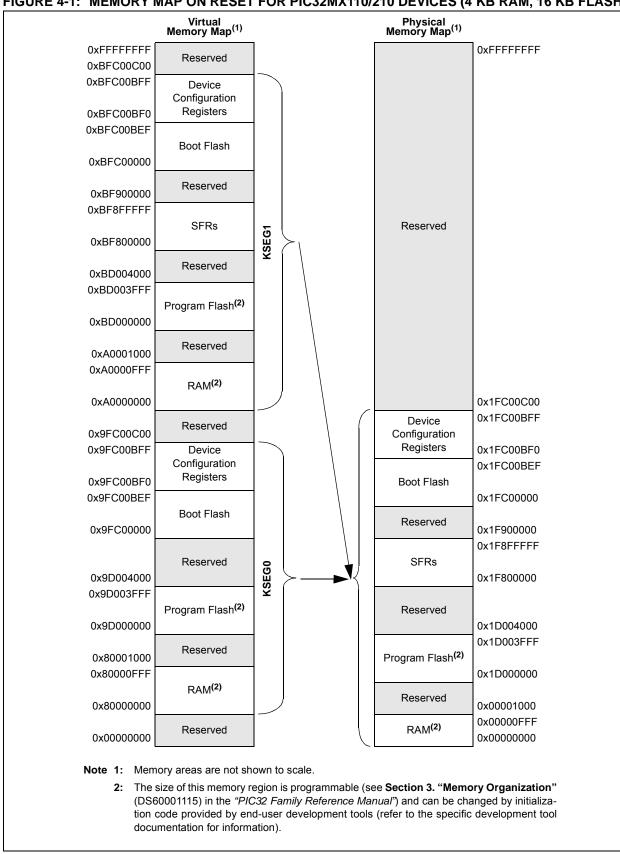


FIGURE 4-1: MEMORY MAP ON RESET FOR PIC32MX110/210 DEVICES (4 KB RAM, 16 KB FLASH)

REGISTER 4-2: BMXDKPBA: DATA RAM KERNEL PROGRAM BASE ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	-	-	_	-		_	_
22.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	_	_	_	_
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0
15:8	BMXDKPBA<15:8>							
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
7:0		·		BMXDK	PBA<7:0>			

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-10 BMXDKPBA<15:10>: DRM Kernel Program Base Address bits

When non-zero, this value selects the relative base address for kernel program space in RAM

bit 9-0 BMXDKPBA<9:0>: Read-Only bits

This value is always '0', which forces 1 KB increments

Note 1: At Reset, the value in this register is forced to zero, which causes all of the RAM to be allocated to Kernal mode data usage.

2: The value in this register must be less than or equal to BMXDRMSZ.

8.0 OSCILLATOR CONFIGURATION

Note:

This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 6. "Oscillator Configuration"** (DS60001112), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

The PIC32MX1XX/2XX 28/36/44-pin Family oscillator system has the following modules and features:

- Four external and internal oscillator options as clock sources
- On-Chip PLL with user-selectable input divider, multiplier and output divider to boost operating frequency on select internal and external oscillator sources
- On-Chip user-selectable divisor postscaler on select oscillator sources
- Software-controllable switching between various clock sources
- A Fail-Safe Clock Monitor (FSCM) that detects clock failure and permits safe application recovery or shutdown
- · Dedicated On-Chip PLL for USB peripheral

A block diagram of the oscillator system is provided in Figure 8-1.

REGISTER 9-18: DCHxDAT: DMA CHANNEL 'x' PATTERN DATA REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	-	_	_	_	_	_	_	_
22.46	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	_	_	_	_
45.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	-	_	_	-	_	_	-	_
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0		_		CHPDAT	Γ<7:0>	_		

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7-0 CHPDAT<7:0>: Channel Data Register bits

Pattern Terminate mode:

Data to be matched must be stored in this register to allow a "terminate on match".

All other modes: Unused.

REGISTER 10-8: U1EIR: USB ERROR INTERRUPT STATUS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	_	-	_	_	_	_	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	-	-	1	-	-	_	-	_
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.6	-	-	-	-	-	_		_
	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS
7:0	BTSEF	BMXEF	DMAEF ⁽¹⁾	BTOEF ⁽²⁾	DFN8EF	CRC16EF	CRC5EF ⁽⁴⁾	PIDEF
	BISEF	DIVIALI	DIVIALITY	BIOEL	DENOLE	CKCTOLF	EOFEF ^(3,5)	FIDER

Legend:WC = Write '1' to clearHS = Hardware Settable bitR = Readable bitW = Writable bitU = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7 BTSEF: Bit Stuff Error Flag bit

1 = Packet rejected due to bit stuff error

0 = Packet accepted

bit 6 BMXEF: Bus Matrix Error Flag bit

1 = The base address, of the Buffer Descriptor Table, or the address of an individual buffer pointed to by a Buffer Descriptor Table entry, is invalid.

0 = No address error

bit 5 **DMAEF:** DMA Error Flag bit⁽¹⁾

1 = USB DMA error condition detected

0 = No DMA error

bit 4 **BTOEF:** Bus Turnaround Time-Out Error Flag bit⁽²⁾

1 = Bus turnaround time-out has occurred

0 = No bus turnaround time-out

bit 3 **DFN8EF:** Data Field Size Error Flag bit

1 = Data field received is not an integral number of bytes

0 = Data field received is an integral number of bytes

bit 2 CRC16EF: CRC16 Failure Flag bit

1 = Data packet rejected due to CRC16 error

0 = Data packet accepted

- **Note 1:** This type of error occurs when the module's request for the DMA bus is not granted in time to service the module's demand for memory, resulting in an overflow or underflow condition, and/or the allocated buffer size is not sufficient to store the received data packet causing it to be truncated.
 - 2: This type of error occurs when more than 16-bit-times of Idle from the previous End-of-Packet (EOP) has elapsed.
 - **3:** This type of error occurs when the module is transmitting or receiving data and the SOF counter has reached zero.
 - 4: Device mode.
 - 5: Host mode.

REGISTER 10-12: U1ADDR: USB ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	-	_	-	_	_	_	-	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	_	-	_	_	_	_	_
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.6	_	_	_	_	_	_	_	_
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7.0	LSPDEN			D	EVADDR<6:0)>		

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7 LSPDEN: Low-Speed Enable Indicator bit

1 = Next token command to be executed at Low-Speed0 = Next token command to be executed at Full-Speed

bit 6-0 **DEVADDR<6:0>:** 7-bit USB Device Address bits

REGISTER 10-13: U1FRML: USB FRAME NUMBER LOW REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	-	_	_	-	-	_	_	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	_	_	_	_	_	_	_
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.6	1	-	_	-	-	_	-	-
7:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
7:0				FRML	<7:0>			

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7-0 FRML<7:0>: The 11-bit Frame Number Lower bits

The register bits are updated with the current frame number whenever a SOF TOKEN is received.

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TABLE 11-5:	PORTC REGISTER MAP	
IADLE II-J.	PURIC REGISTER WAR	

ess												Bits							10
Virtual Address (BF88_#)	Register Name ^(1,2)	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
6200	ANSELC	31:16	ı	_	_	_	_	_	I	1	_	_	_	1	_	_	ı	ı	0000
0200	ANSELC	15:0	-	_	_	_	_	_	_	-	_	_	_	_	ANSC3 ⁽⁴⁾	ANSC2 ⁽³⁾	ANSC1	ANSC0	000F
6210	TRISC	31:16	_	_	_	_	_	_			_	_	_		_	_	_	_	0000
0210	TRISC	15:0	I	_	_	_	_		TRISC9	TRISC8 ⁽³⁾	TRISC7 ⁽³⁾	TRISC6 ⁽³⁾	TRISC5 ⁽³⁾	TRISC4 ⁽³⁾	TRISC3	TRISC2 ⁽³⁾	TRISC1	TRISC0	03FF
6220	PORTC	31:16	I	_	_	_	_	_	1	1	_	_	_						0000
0220	PORIC	15:0	_	_	_	_	_	_	RC9	RC8 ⁽³⁾	RC7 ⁽³⁾	RC6 ⁽³⁾	RC5 ⁽³⁾	RC4 ⁽³⁾	RC3	RC2 ⁽³⁾	RC1	RC0	xxxx
6230	LATC	31:16	I	_	_	_	_	_	1	1	_	_	_	1	_	_	-	-	0000
0230	LKI	15:0	I	_	_	_	_	_	LATC9	LATC8 ⁽³⁾	LATC7 ⁽³⁾	LATC6 ⁽³⁾	LATC5 ⁽³⁾	LATC4 ⁽³⁾	LATC3	LATC2 ⁽³⁾	LATC1	LATC0	xxxx
6240	ODCC	31:16	I	_	_	_	_	_	1	1	_	_	_	1	_	_	-	-	0000
0240	ODCC	15:0	_	_	_	_	_	_	ODCC9	ODCC8 ⁽³⁾	ODCC7 ⁽³⁾	ODCC6 ⁽³⁾	ODCC5 ⁽³⁾	ODCC4 ⁽³⁾	ODCC3	ODCC2 ⁽³⁾	ODCC1	ODCC0	0000
6250	CNPUC	31:16	I	_	_	_	_	_	1	1	_	_	_	1	_	_	-	-	0000
0250	CNPUC	15:0	I	_	_	_	_	_	CNPUC9	CNPUC8 ⁽³⁾	CNPUC7 ⁽³⁾	CNPUC6 ⁽³⁾	CNPUC5 ⁽³⁾	CNPUC4 ⁽³⁾	CNPUC3	CNPUC2 ⁽³⁾	CNPUC1	CNPUC0	0000
0000	CNIDDO	31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000
6260	CNPDC	15:0	_	_	_	_	_	_	CNPDC9	CNPDC8 ⁽³⁾	CNPDC7 ⁽³⁾	CNPDC6 ⁽³⁾	CNPDC5 ⁽³⁾	CNPDC4 ⁽³⁾	CNPDC3	CNPDC2 ⁽³⁾	CNPDC1	CNPDC0	0000
6070	CNICONIC	31:16	I	_	_	_	_	_	1	1	_	_	_	1	_	_	-	-	0000
0270	CNCONC	15:0	ON	_	SIDL	_	_	_	1	1	_	_	_	1	_	_	-	-	0000
6200	CNENC	31:16	I	_	_	_	_	_			_	_	_		_	_	_		0000
6280	CNENC	15:0	I	_	_	_	_	_	CNIEC9	CNIEC8 ⁽³⁾	CNIEC7 ⁽³⁾	CNIEC6(3)	CNIEC5 ⁽³⁾	CNIEC4 ⁽³⁾	CNIEC3	CNIEC2 ⁽³⁾	CNIEC1	CNIEC0	0000
6200	CNICTATO	31:16	I	_	_	_	_	_			_		_		_	_	_		0000
0290	CNSTATC	15:0		_	_	_	_	_	CNSTATC9	CNSTATC8(3)	CNSTATC7 ⁽³⁾	CNSTATC6 ⁽³⁾	CNSTATC5 ⁽³⁾	CNSTATC4(3)	CNSTATC3	CNSTATC2 ⁽³⁾	CNSTATC1	CNSTATCO	0000

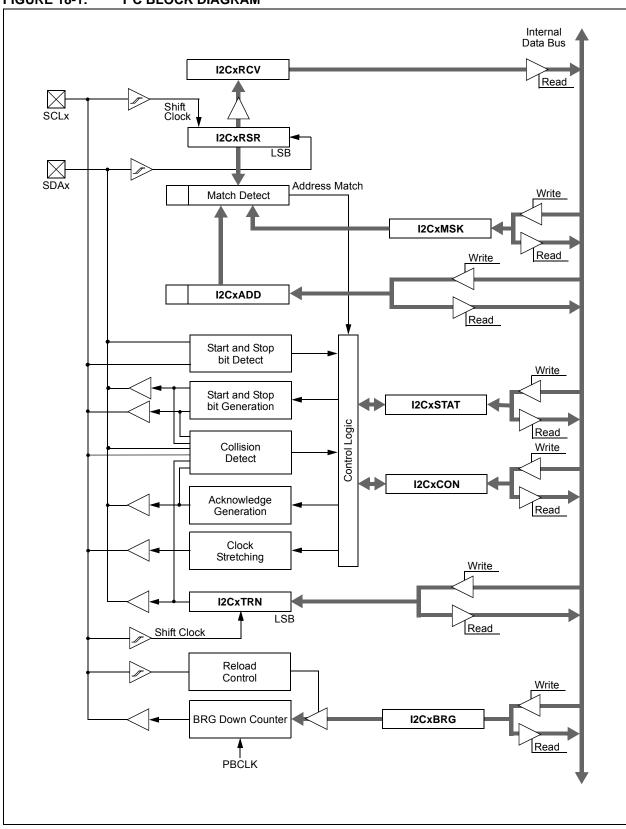
 ${f x}$ = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

- PORTC is not available on 28-pin devices. 2:
- This bit is only available on 44-pin devices.
- This bit is only available on USB-enabled devices with 36 or 44 pins.

FIGURE 18-1: I²C BLOCK DIAGRAM



REGISTER 19-1: UxMODE: UARTX MODE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	1	_	_	-	_	_	_	_
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	_	_	_	_
45.0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
15:8	ON ⁽¹⁾	_	SIDL	IREN	RTSMD	_	UEN.	<1:0>
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL	<1:0>	STSEL

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15 ON: UARTx Enable bit(1)

- 1 = UARTx is enabled. UARTx pins are controlled by UARTx as defined by the UEN<1:0> and UTXEN control bits.
- 0 = UARTx is disabled. All UARTx pins are controlled by corresponding bits in the PORTx, TRISx and LATx registers; UARTx power consumption is minimal.
- bit 14 Unimplemented: Read as '0'
- bit 13 SIDL: Stop in Idle Mode bit
 - 1 = Discontinue module operation when the device enters Idle mode
 - 0 = Continue module operation when the device enters Idle mode
- bit 12 IREN: IrDA Encoder and Decoder Enable bit
 - 1 = IrDA is enabled
 - 0 = IrDA is disabled
- bit 11 RTSMD: Mode Selection for UxRTS Pin bit
 - $1 = \overline{\text{UxRTS}}$ pin is in Simplex mode
 - $0 = \overline{\text{UxRTS}}$ pin is in Flow Control mode
- bit 10 Unimplemented: Read as '0'
- bit 9-8 **UEN<1:0>:** UARTx Enable bits
 - 11 = UxTX, UxRX and UxBCLK pins are enabled and used; UxCTS pin is controlled by corresponding bits in the PORTx register
 - 10 = UxTX, UxRX, $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ pins are enabled and used
 - 01 = UxTX, UxRX and $\overline{\text{UxRTS}}$ pins are enabled and used; $\overline{\text{UxCTS}}$ pin is controlled by corresponding bits in the PORTx register
 - 00 = UxTX and UxRX pins are enabled and used; UxCTS and UxRTS/UxBCLK pins are controlled by corresponding bits in the PORTx register
- bit 7 WAKE: Enable Wake-up on Start bit Detect During Sleep Mode bit
 - 1 = Wake-up enabled
 - 0 = Wake-up disabled
- bit 6 LPBACK: UARTx Loopback Mode Select bit
 - 1 = Loopback mode is enabled
 - 0 = Loopback mode is disabled
- **Note 1:** When using 1:1 PBCLK divisor, the user software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

REGISTER 21-1: RTCCON: RTC CONTROL REGISTER (CONTINUED)

- bit 5-4 **Unimplemented:** Read as '0'
- bit 3 RTCWREN: RTC Value Registers Write Enable bit (4)
 - 1 = RTC Value registers can be written to by the user
 - 0 = RTC Value registers are locked out from being written to by the user
- bit 2 RTCSYNC: RTCC Value Registers Read Synchronization bit
 - 1 = RTC Value registers can change while reading, due to a rollover ripple that results in an invalid data read If the register is read twice and results in the same data, the data can be assumed to be valid
 - 0 = RTC Value registers can be read without concern about a rollover ripple
- bit 1 HALFSEC: Half-Second Status bit⁽⁵⁾
 - 1 = Second half period of a second
 - 0 = First half period of a second
- bit 0 RTCOE: RTCC Output Enable bit
 - 1 = RTCC clock output enabled clock presented onto an I/O
 - 0 = RTCC clock output disabled
- **Note 1:** The ON bit is only writable when RTCWREN = 1.
 - 2: When using the 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - 3: Requires RTCOE = 1 (RTCCON<0>) for the output to be active.
 - **4:** The RTCWREN bit can be set only when the write sequence is enabled.
 - 5: This bit is read-only. It is cleared to '0' on a write to the seconds bit fields (RTCTIME<14:8>).

Note: This register is reset only on a Power-on Reset (POR).

23.0 COMPARATOR

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer Section to "Comparator" (DS60001110), which is available from the Documentation Reference Manual section the Microchip PIC32 web site (www.microchip.com/pic32).

The Analog Comparator module contains three comparators that can be configured in a variety of ways.

Following are some of the key features of this module:

- · Selectable inputs available include:
 - Analog inputs multiplexed with I/O pins
 - On-chip internal absolute voltage reference (IVREF)
 - Comparator voltage reference (CVREF)
- · Outputs can be Inverted
- · Selectable interrupt generation

A block diagram of the comparator module is provided in Figure 23-1.

FIGURE 23-1: COMPARATOR BLOCK DIAGRAM

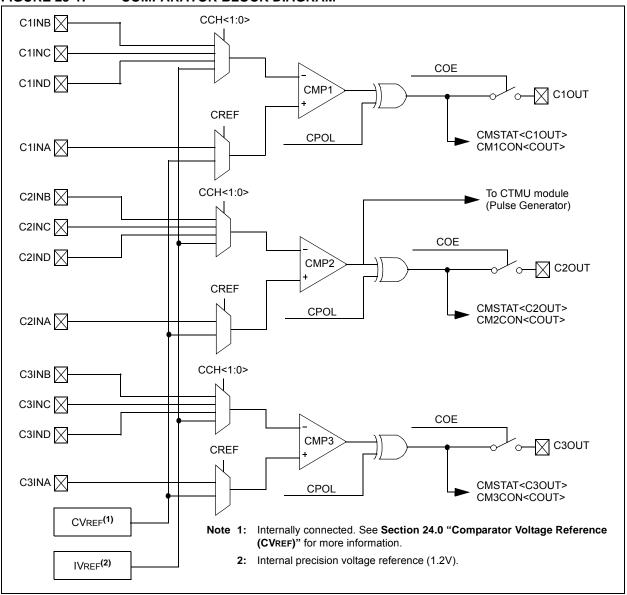


TABLE 30-33: I2Cx BUS DATA TIMING REQUIREMENTS (SLAVE MODE)

	Standard Operating Conditions: 2.3V to 3.6V	
AC CHARACTERISTICS	(unless otherwise stated)	
	Operating temperature -40°C ≤ TA ≤ +85°C for Industria	al
	-40°C ≤ TA ≤ +105°C for V-temp)

	_	T-			$C \le IA \le +105^{\circ}C$ for V-temp		
Param. No.	Symbol Characte		eristics	Min.	Max.	Units	Conditions
IS10	TLO:SCL	Clock Low Time	100 kHz mode	4.7	_	μS	PBCLK must operate at a minimum of 800 kHz
			400 kHz mode	1.3	_	μS	PBCLK must operate at a minimum of 3.2 MHz
			1 MHz mode (Note 1)	0.5		μS	_
IS11	THI:SCL	Clock High Time	100 kHz mode	4.0	_	μS	PBCLK must operate at a minimum of 800 kHz
			400 kHz mode	0.6	_	μS	PBCLK must operate at a minimum of 3.2 MHz
			1 MHz mode (Note 1)	0.5	_	μS	_
IS20	TF:SCL	SDAx and SCLx	100 kHz mode	_	300	ns	CB is specified to be from
İ		Fall Time	400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF
			1 MHz mode (Note 1)	_	100	ns	
IS21	TR:SCL	SDAx and SCLx Rise Time	100 kHz mode	_	1000	ns	CB is specified to be from
			400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF
			1 MHz mode (Note 1)	_	300	ns	
IS25	Tsu:dat	Data Input	100 kHz mode	250	_	ns	_
		Setup Time	400 kHz mode	100	_	ns	
			1 MHz mode (Note 1)	100	_	ns	
IS26	THD:DAT	Data Input	100 kHz mode	0	_	ns	_
		Hold Time	400 kHz mode	0	0.9	μS	
			1 MHz mode (Note 1)	0	0.3	μS	
IS30	Tsu:sta	Start Condition	100 kHz mode	4700	_	ns	Only relevant for Repeated
		Setup Time	400 kHz mode	600	_	ns	Start condition
			1 MHz mode (Note 1)	250	_	ns	
IS31	THD:STA	Start Condition	100 kHz mode	4000	_	ns	After this period, the first
		Hold Time	400 kHz mode	600	_	ns	clock pulse is generated
			1 MHz mode (Note 1)	250	_	ns	
IS33	Tsu:sto	Stop Condition	100 kHz mode	4000	_	ns	_
		Setup Time	400 kHz mode	600	_	ns	
			1 MHz mode (Note 1)	600	_	ns	

Note 1: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

TABLE 30-33: I2Cx BUS DATA TIMING REQUIREMENTS (SLAVE MODE) (CONTINUED)

AC CHARACTERISTICS							
Param. No.	Symbol	Charact	Min.	Max.	Units	Conditions	
IS34	THD:STO	Stop Condition	100 kHz mode	4000	_	ns	_
		Hold Time	400 kHz mode	600	_	ns	
			1 MHz mode (Note 1)	250		ns	
IS40	TAA:SCL	Output Valid from Clock	100 kHz mode	0	3500	ns	_
			400 kHz mode	0	1000	ns	
			1 MHz mode (Note 1)	0	350	ns	
IS45	TBF:SDA	Bus Free Time	100 kHz mode	4.7	_	μS	The amount of time the bus
			400 kHz mode	1.3		μS	must be free before a new
			1 MHz mode (Note 1)	0.5	_	μS	transmission can start
IS50	Св	Bus Capacitive Lo	ading	_	400	pF	_

Note 1: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

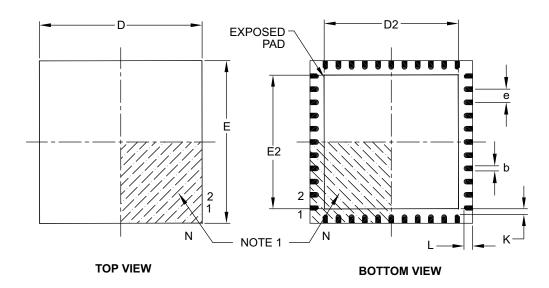
TABLE 30-34: ADC MODULE SPECIFICATIONS

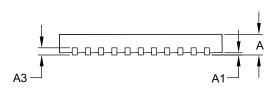
	AC CHAF	RACTERISTICS	Standard Operating Conditions (see Note 5): 2.5V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +105^{\circ}\text{C}$ for V-temp						
Param. No.	Symbol	Characteristics	Min.	Typical	Max.	Units	Conditions		
Device	Supply								
AD01	AVDD	Module VDD Supply	Greater of VDD – 0.3 or 2.5	Ī	Lesser of VDD + 0.3 or 3.6	V	_		
AD02	AVss	Module Vss Supply	Vss		AVDD	V	(Note 1)		
Referen	ce Inputs								
AD05 AD05a	VREFH	Reference Voltage High	AVss + 2.0 2.5		AVDD 3.6	V V	(Note 1) VREFH = AVDD (Note 3)		
AD06	VREFL	Reference Voltage Low	AVss		VREFH - 2.0	V	(Note 1)		
AD07	VREF	Absolute Reference Voltage (VREFH – VREFL)	2.0	1	AVDD	V	(Note 3)		
AD08 AD08a	IREF	Current Drain		250 —	400 3	μA μA	ADC operating ADC off		
Analog	Input								
AD12	VINH-VINL	Full-Scale Input Span	VREFL	_	VREFH	V	_		
AD13	VINL	Absolute VINL Input Voltage	AVss - 0.3	_	AVDD/2	V	_		
AD14	Vin	Absolute Input Voltage	AVss - 0.3	_	AVDD + 0.3	V	_		
AD15	_	Leakage Current	_	±0.001	±0.610	μA	VINL = AVSS = VREFL = 0V, AVDD = VREFH = $3.3V$ Source Impedance = $10 \text{ k}\Omega$		
AD17	Rin	Recommended Impedance of Analog Voltage Source	_	_	5k	Ω	(Note 1)		
ADC Ac	curacy – N	leasurements with Exte	rnal VREF+/V	REF-					
AD20c	Nr	Resolution		10 data bit	s	bits	_		
AD21c	INL	Integral Non-linearity	> -1	_	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V		
AD22c	DNL	Differential Non-linearity	> -1	_	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V (Note 2)		
AD23c	GERR	Gain Error	> -1	_	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V		
AD24c	EOFF	Offset Error	> -1	_	< 1	Lsb	VINL = AVSS = 0V, AVDD = 3.3V		
AD25c	_	Monotonicity	_	_	_	_	Guaranteed		

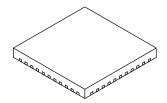
- **Note 1:** These parameters are not characterized or tested in manufacturing.
 - 2: With no missing codes.
 - **3:** These parameters are characterized, but not tested in manufacturing.
 - 4: Characterized with a 1 kHz sine wave.
 - **5:** The ADC module is functional at VBORMIN < VDD < 2.5V, but with degraded performance. Unless otherwise stated, module functionality is tested, but not characterized.

44-Lead Plastic Quad Flat, No Lead Package (ML) - 8x8 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging







	Units		MILLIMETERS	3	
	Dimension Limits	MIN	NOM	MAX	
Number of Pins	N		44		
Pitch	е		0.65 BSC		
Overall Height	A	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3		0.20 REF		
Overall Width	E		8.00 BSC		
Exposed Pad Width	E2	6.30	6.45	6.80	
Overall Length	D	8.00 BSC			
Exposed Pad Length	D2	6.30	6.45	6.80	
Contact Width	b	0.25	0.30	0.38	
Contact Length	L	0.30	0.40	0.50	
Contact-to-Exposed Pad	K	0.20	-	_	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-103B

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